

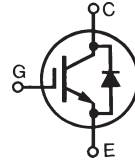
# High Voltage, High Gain BIMOSFET™ Monolithic Bipolar MOS Transistor

## IXBA10N300HV IXBH10N300HV

$$V_{CES} = 3000V$$

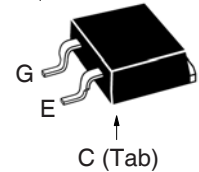
$$I_{C110} = 10A$$

$$V_{CE(sat)} \leq 2.8V$$

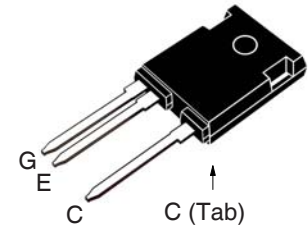


| Symbol                                       | Test Conditions  | Maximum Ratings       |            |
|--|--|-----------------------|------------|
| $V_{CES}$                                    | $T_C = 25^\circ C$ to $150^\circ C$  | 3000                  | V          |
| $V_{CGR}$                                    | $T_J = 25^\circ C$ to $150^\circ C$ , $R_{GE} = 1M\Omega$                                      | 3000                  | V          |
| $V_{GES}$                                    | Continuous   | $\pm 20$              | V          |
| $V_{GEM}$                                    | Transient  | $\pm 30$              | V          |
| $I_{C25}$                                    | $T_C = 25^\circ C$   | 34                    | A          |
| $I_{C110}$                                   | $T_C = 110^\circ C$  | 10                    | A          |
| $I_{CM}$                                     | $T_C = 25^\circ C$ , 1ms   | 88                    | A          |
| <b>SSOA</b><br><b>(RBSOA)</b>                | $V_{GE} = 15V$ , $T_{VJ} = 125^\circ C$ , $R_G = 10\Omega$<br>Clamped Inductive Load           | $I_{CM} = 80$<br>1500 | A<br>V     |
| <b><math>T_{SC}</math></b><br><b>(SCSOA)</b> | $V_{GE} = 15V$ , $T_J = 125^\circ C$ ,<br>$R_G = 82\Omega$ , $V_{CE} = 1500V$ , Non-Repetitive | 10                    | $\mu s$    |
| $P_C$  | $T_C = 25^\circ C$   | 180                   | W          |
| $T_J$  |  | -55 ... +150          | $^\circ C$ |
| $T_{JM}$                                     |  | 150                   | $^\circ C$ |
| $T_{stg}$                                    |  | -55 ... +150          | $^\circ C$ |
| $T_L$  | Maximum Lead Temperature for Soldering   | 300                   | $^\circ C$ |
| $T_{SOLD}$                                   | 1.6 mm (0.062in.) from Case for 10s  | 260                   | $^\circ C$ |
| $F_C$  | Mounting Force (TO-263HV)  | 10..65 / 22..14.6     | N/lb       |
| $M_d$  | Mounting Torque (TO-247HV)   | 1.13/10               | Nm/lb.in   |
| <b>Weight</b>                                | TO-263HV   | 2.5                   | g          |
|  | TO-247HV   | 6.0                   | g          |

TO-263HV (IXBA)



TO-247HV (IXBH)



G = Gate      C = Collector  
E = Emitter    Tab = Collector

### Features

- High Blocking Voltage
- Anti-Parallel Diode
- Low Conduction Losses

### Advantages

- Low Gate Drive Requirement
- High Power Density

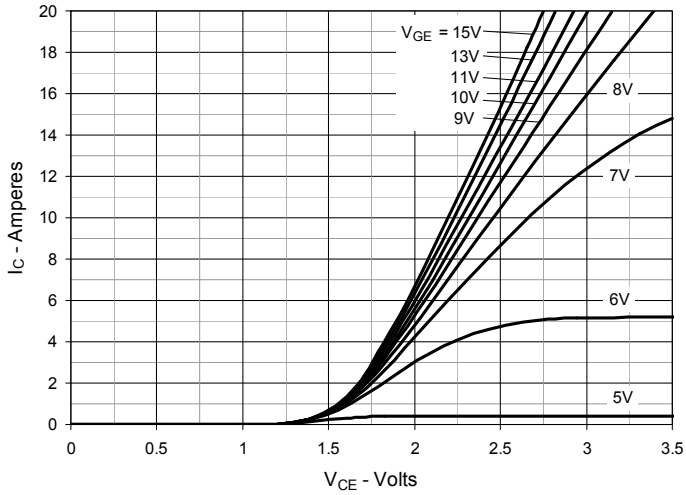
### Applications

- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies (UPS)
- Laser Generators
- Capacitor Discharge Circuits
- AC Switches

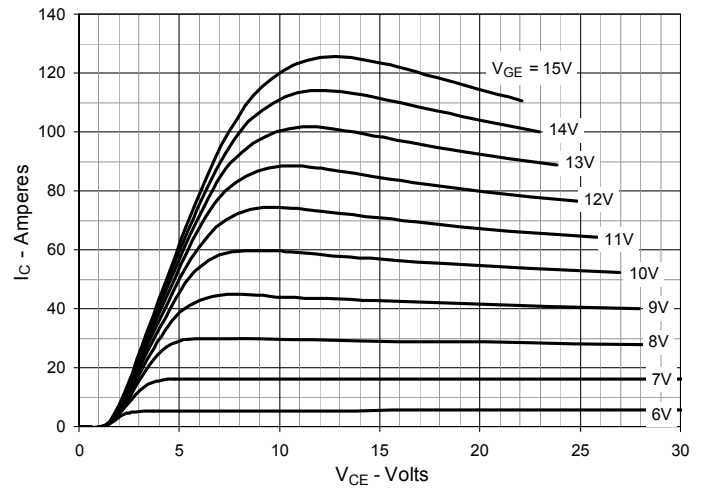
| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ Unless Otherwise Specified) | Characteristic Values |            |                           |
|---------------|---|-----------------------|------------|---------------------------|
|               |   | Min.                  | Typ.       | Max.                      |
| $BV_{CES}$    | $I_C = 250\mu A$ , $V_{GE} = 0V$                                    | 3000                  |            | V                         |
| $V_{GE(th)}$  | $I_C = 250\mu A$ , $V_{CE} = V_{GE}$                                | 3.0                   |            | V                         |
| $I_{CES}$     | $V_{CE} = 0.8 \cdot V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 125^\circ C$ |                       |            | 25 $\mu A$<br>500 $\mu A$ |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                  |                       |            | $\pm 100$ nA              |
| $V_{CE(sat)}$ | $I_C = 10A$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 125^\circ C$        |                       | 2.2<br>2.7 | 2.8<br>V                  |



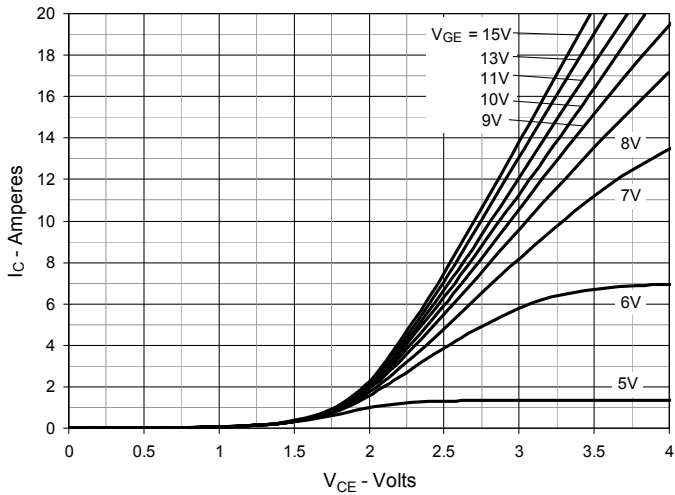
**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$**



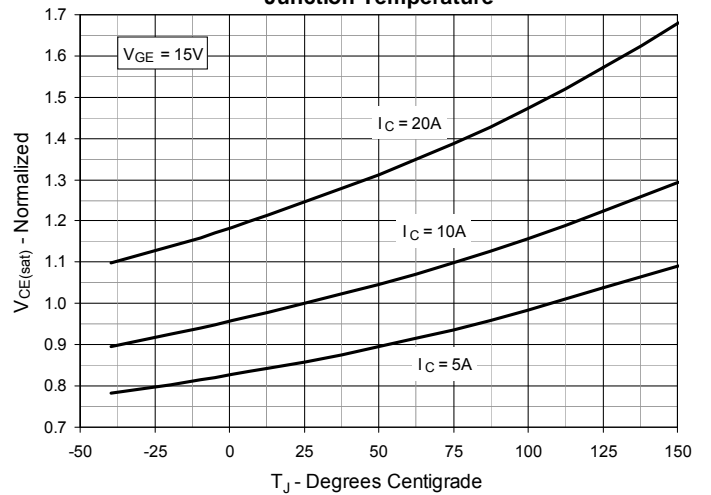
**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$**



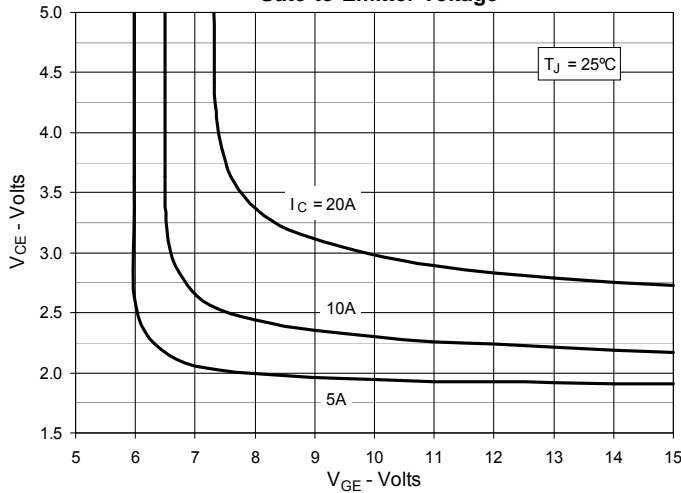
**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$**



**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**



**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



**Fig. 6. Input Admittance**

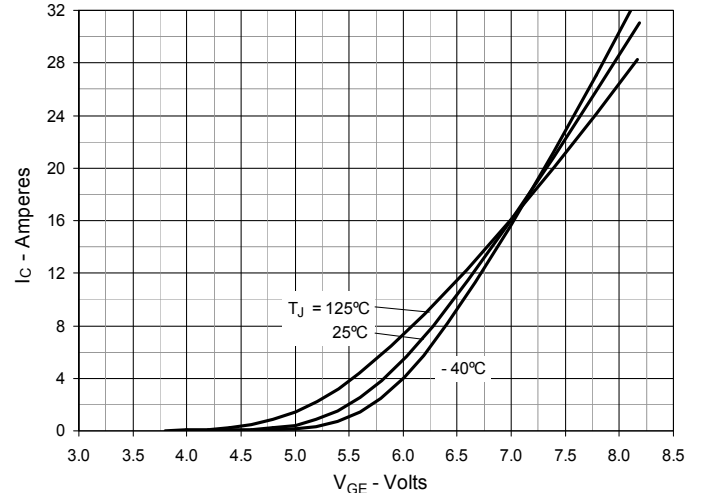


Fig. 7. Transconductance

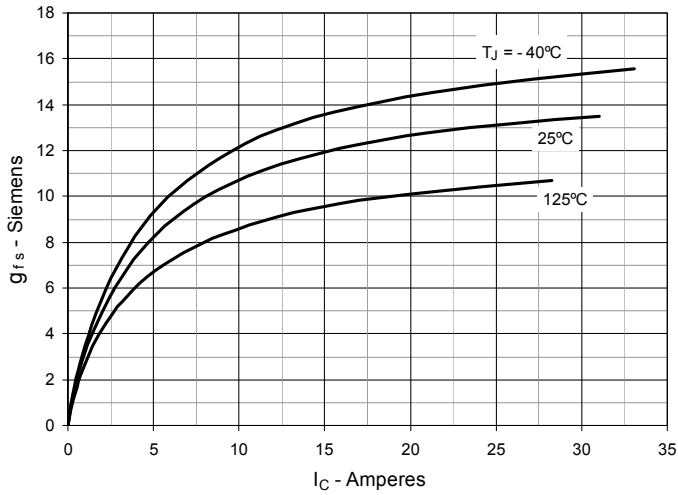


Fig. 8. Forward Voltage Drop of Intrinsic Diode

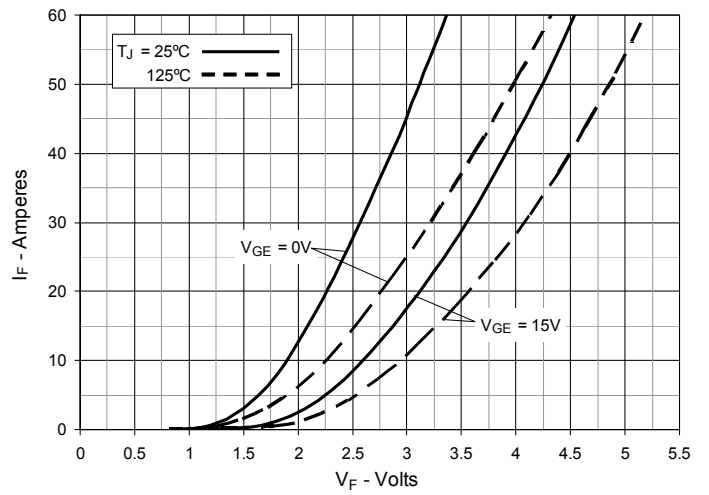


Fig. 9. Gate Charge

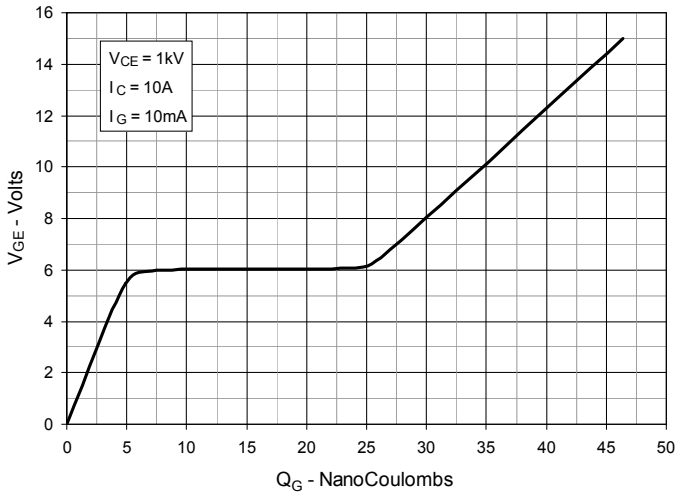


Fig. 10. Capacitance

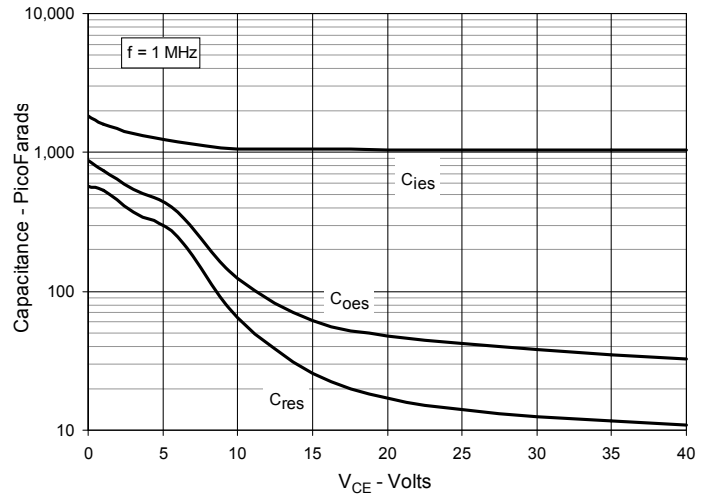


Fig. 11. Reverse-Bias Safe Operating Area

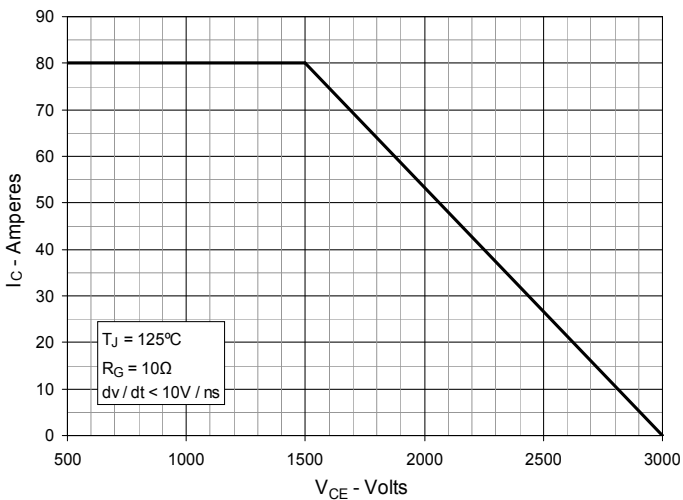
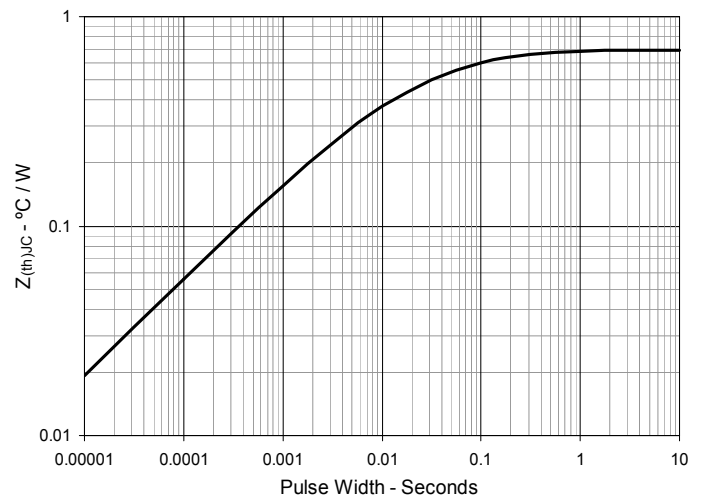
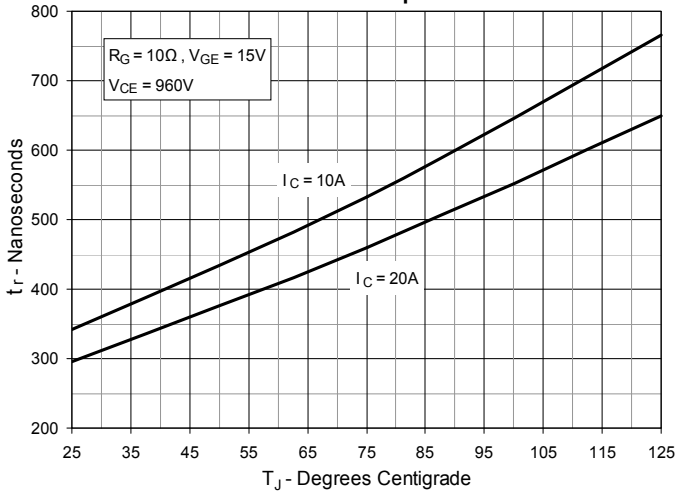


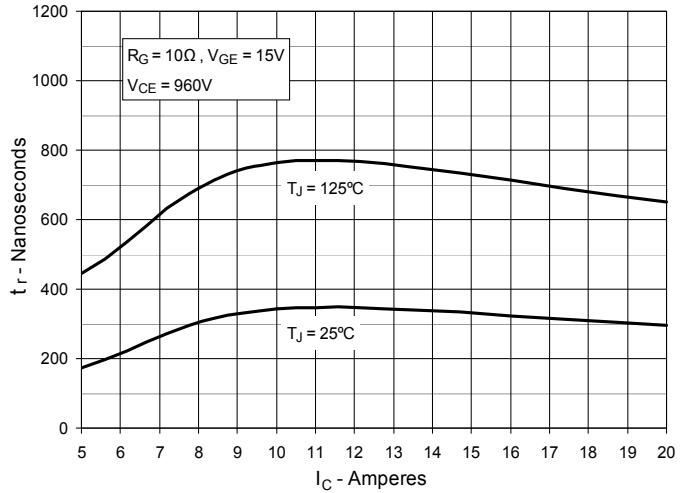
Fig. 12. Maximum Transient Thermal Impedance



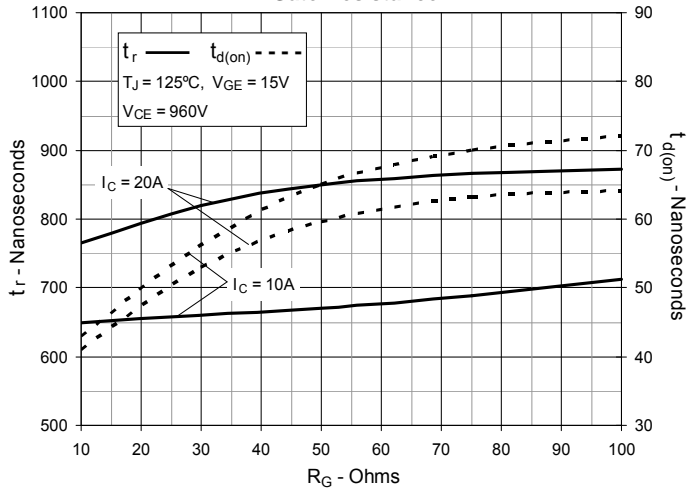
**Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature**



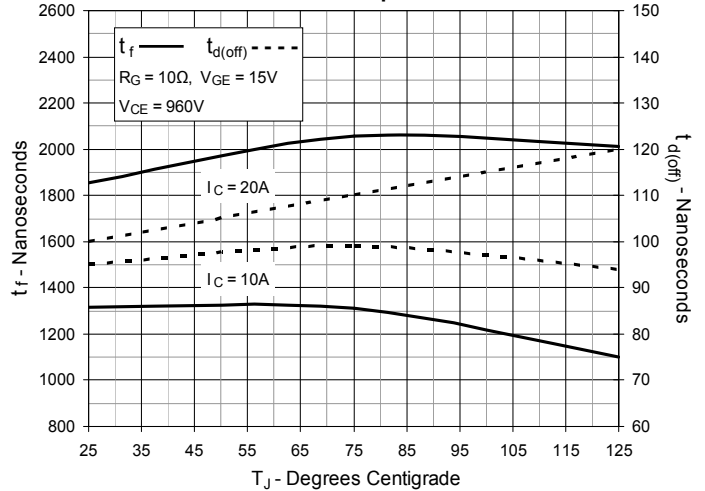
**Fig. 14. Resistive Turn-on Rise Time vs. Collector Current**



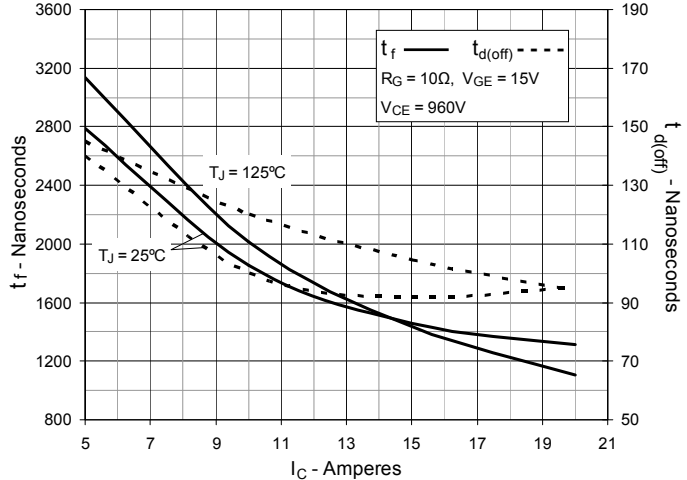
**Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance**



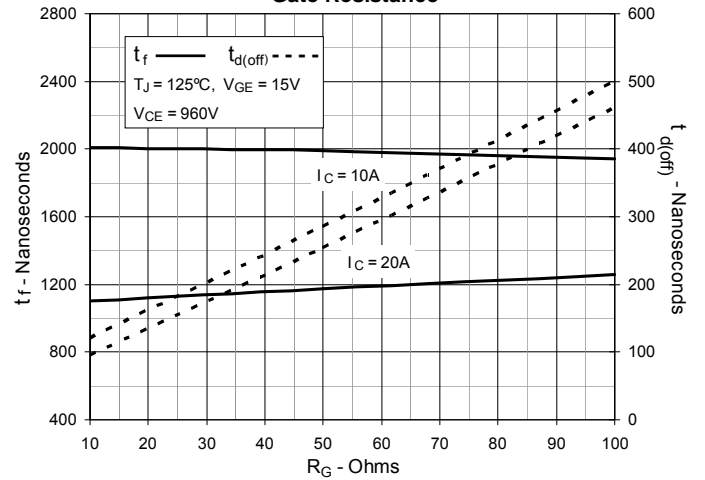
**Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature**



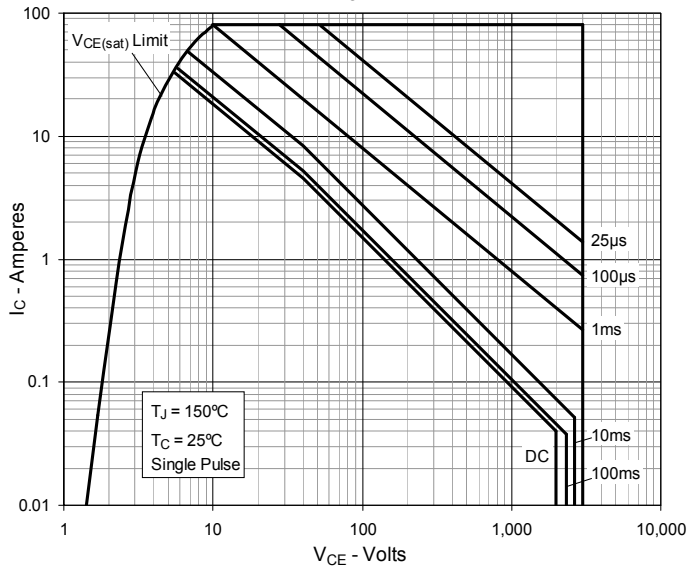
**Fig. 17. Resistive Turn-off Switching Times vs. Collector Current**



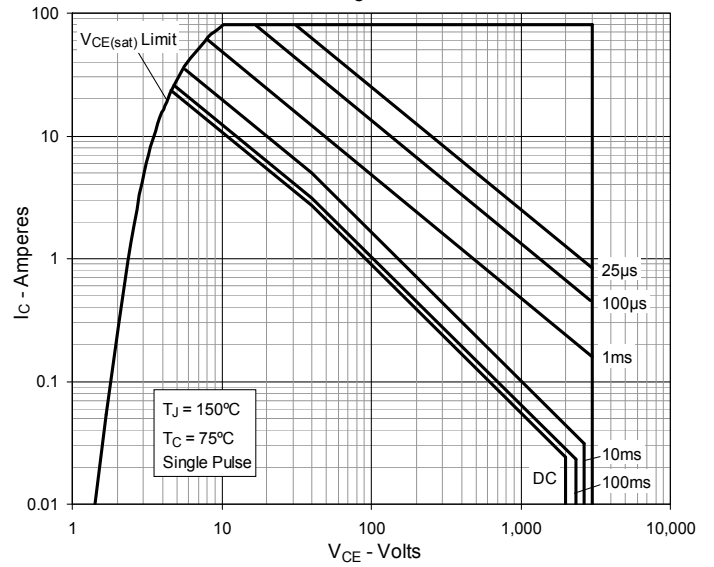
**Fig. 28. Resistive Turn-off Switching Times vs. Gate Resistance**



**Fig. 19. Forward-Bias Safe Operating Area**  
**@  $T_C = 25^\circ\text{C}$**



**Fig. 20. Forward-Bias Safe Operating Area**  
**@  $T_C = 75^\circ\text{C}$**





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